LDMOS 2-stage integrated Doherty MMIC

Rev. 1 — 13 October 2020

1. Product profile

1.1 General description

The BLM9D2324-08AM is a 2-stage 8 W fully integrated Doherty MMIC solution using Ampleon's state of the art GEN9 LDMOS technology. The carrier and peaking device, input splitter and output combiner are integrated in a single package. This multiband device is perfectly suited as a device in the frequency range from 2300 MHz to 2400 MHz. Available in LGA outline.

Table 1.Performance

Typical RF performance at $T_{case} = 25$ °C; $I_{Dq} = 18$ mA (driver and final stages) in a demo circuit; $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55$ V.

Test signal	f	V _{DS}	P _{L(AV)}	G _p	ησ	
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)
single carrier W-CDMA [1]	2350	28	1.12	27	41	-30

[1] Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

1.2 Features and benefits

- Integrated input splitter
- Integrated output combiner
- Very high efficiency
- Designed for broadband operation (frequency 2300 MHz to 2400 MHz)
- Independent control of carrier and peaking bias
- Integrated ESD protection
- Excellent thermal stability
- High power gain, input and output matched to impedance 50 Ω
- For RoHS compliance see the product details on the Ampleon website

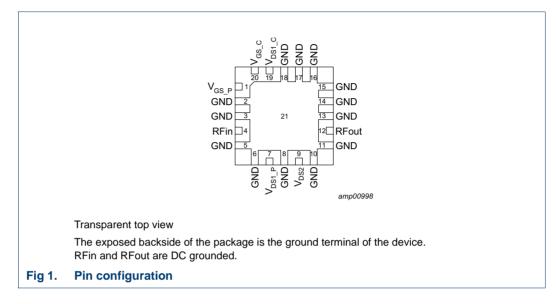
1.3 Applications

 RF power MMIC for multi-carrier and multi-standard GSM, W-CDMA, LTE and NR small cell base stations in the 2300 MHz to 2400 MHz frequency range

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2. Pinning information

2.1 Pinning



2.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
V _{GS_P}	1	gate-source voltage of peaking
GND	2	ground
GND	3	ground
RFin	4	RF input
GND	5	ground
GND	6	ground
V _{DS1_P}	7	drain-source voltage of peaking driver
GND	8	ground
V _{DS2}	9	drain-source voltage of final stages
GND	10	ground
GND	11	ground
RFout	12	RF output
GND	13	ground
GND	14	ground
GND	15	ground
GND	16	ground
GND	17	ground
GND	18	ground

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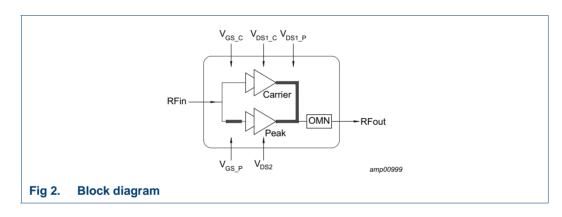
Table 2. Pin descriptioncontinued					
Symbol		Pin	Description		
V _{DS1_C}		19	drain-source voltage of carrier driver		
V _{GS_C}	:	20	gate-source voltage of carrier driver		
GND		21	RF ground		

3. Ordering information

Table 3. Ordering information

Type number	Package						
	Name	Description	Version				
BLM9D2324-08AM		plastic thermal enhanced package; no leads; 20 terminals; body 7.0 x 7.0 x 0.98 mm	LGA-7x7-20-1				

4. Block diagram



5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage		-	65	V
V _{GS}	gate-source voltage		-6	+11	V
T _{stg}	storage temperature		-55	+125	°C
Tj	junction temperature	[1]	-	175	°C
T _{case}	case temperature	[1]	-	125	°C

[1] Continuous use at maximum temperature will affect the reliability. For details refer to the online MTF calculator.

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6. Thermal characteristics

Table 5. Thermal characteristics

Measured for total device.

Symbol	Parameter	Conditions	Value	Unit
R _{th(j-c)}	thermal resistance from junction to	$T_{case} = 80 \ ^{\circ}C; P_{L(AV)} = 1.12 \ W$ [1]	9.2	K/W
	case	$T_{case} = 80 \ ^{\circ}C; \ P_{L(AV)} = 1.78 \ W$ [1]	8.3	K/W

[1] When operated with a 1-carrier W-CDMA with PAR = 7.2 dB.

7. Characteristics

Table 6. DC characteristics

 $T_{case} = 25 \$ °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Carrier	1	1				
V _{GSq}	gate-source quiescent voltage	V _{DS} = 28 V; I _D = 18 mA	1.65	2.05	2.75	V
I _{GSS}	gate leakage current	V_{GS} = 11 V/–5 V; V_{DS} = 0 V	-	-	140	nA
Peaking		1				
I _{GSS}	gate leakage current	V_{GS} = 11 V/–5 V; V_{DS} = 0 V	-	-	140	nA
Final sta	ges	1				
I _{DSS}	drain leakage current	$V_{GS} = 0 V; V_{DS} = 60 V$	-	-	1.4	μΑ
Driver st	ages	I			1	
I _{DSS}	drain leakage current	$V_{GS} = 0 V; V_{DS} = 60 V$	-	-	1.4	μA

Table 7. RF Characteristics

Typical RF performance at $T_{case} = 25 \ ^{\circ}C$; $V_{DS} = 28 \ V$; $I_{Dq} = 18 \ mA$ (carrier); $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55 \ V$; $P_L = 1.12 \ W$; $f = 2.4 \ GHz$. Unless otherwise specified, measured in an Ampleon production circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Test signal: CW pulsed						
G _p	power gain		25	27	29	dB
η _D	drain efficiency		36	42.5	-	%
RL _{in}	input return loss		-	-19	-13	dB
P _{L(3dB)}	output power at 3 dB gain compression		39	40	-	dBm

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8. Application information

Table 8. Typical performance

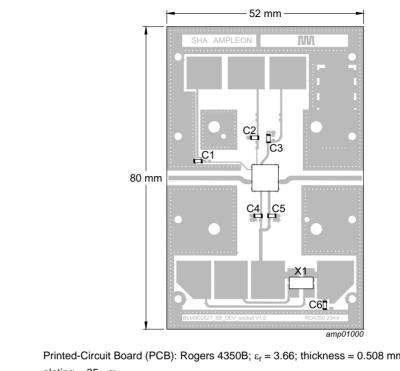
Test signal: 1-carrier W-CDMA; $T_{case} = 25 \, ^{\circ}C$; $V_{DS} = 28 \, V$; $I_{Dq} = 18 \, mA$ (driver and final stages); test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability CCDF; unless otherwise specified, measured in an Ampleon 2300 MHz to 2400 MHz frequency band demo circuit.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
P _{L(3dB)}	output power at 3 dB gain compression	f = 2350 MHz	[1]	-	40	-	dBm
η _D	drain efficiency	$P_{L(AV)} = 30.5 \text{ dBm}; f = 2300 \text{ MHz}$		-	41	-	%
G _p	power gain	$P_{L(AV)} = 30.5 \text{ dBm}; f = 2300 \text{ MHz}$		-	27	-	dB
G _{flat}	gain flatness	P _{L(AV)} = 30.5 dBm; f = 2300 MHz to 2400 MHz		-	0.8	-	dB
ACPR _{5M}	adjacent channel power ratio (5 MHz)	P _{L(AV)} = 30.5 dBm; f = 2300 MHz		-	-30	-	dBc
$\Delta G / \Delta T$	gain variation with temperature	f = 2300 MHz		-	0.04	-	dB/∘C
К	Rollett stability factor	$T_{case} = -40 \text{ °C}; f = 0.15 \text{ GHz to}$ 5 GHz	[2]	-	>1	-	

[1] Pulsed CW power sweep measurement (δ = 10 %, t_p = 100 µs).

[2] S-parameters measured in a demo circuit.

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Printed-Circuit Board (PCB): Rogers 4350B; $\varepsilon_r = 3.66$; thickness = 0.508 mm; thickness of copper plating = 35 µm.

Fig 3. **Component layout**

Table 9. Demo test circuit list of components

See Figure 3 for component layout.

Component	Description	Value	Remarks
C1, C2, C3, C4, C5	multilayer ceramic chip capacitor	1μF [1	
C6	multilayer ceramic chip capacitor	1 μF [2	
X1	current sense resistor	100 mΩ, 1 W	Y44870R10000B0R

[1] American Technical Ceramics type 600F or capacitor of same quality.

[2] Murata or capacitor of same quality.

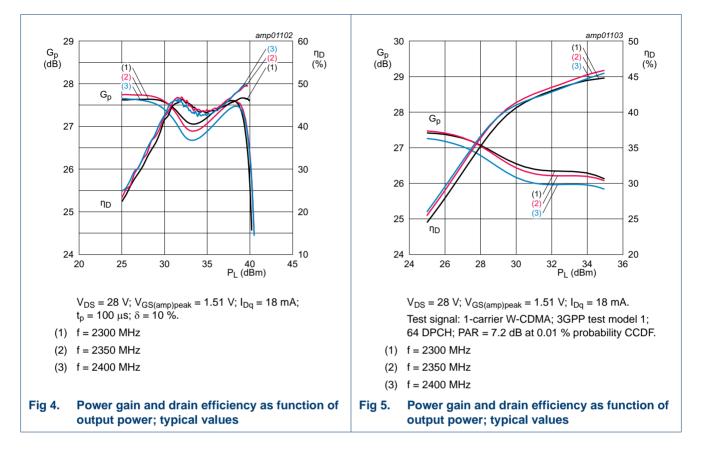
8.1 Ruggedness in a Doherty operation

The BLM9D2324-08AM is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: $V_{DS} = 28 V$; I_{Dq} = 18 mA (carrier); $V_{GSq(peaking)} = V_{GSq(carrier)} - 0.55$ V; P_i corresponding to P_{L(3dB)} under $Z_S = 50 \Omega$ load; f = 2300 MHz (CW); $T_{case} = 25$ °C.

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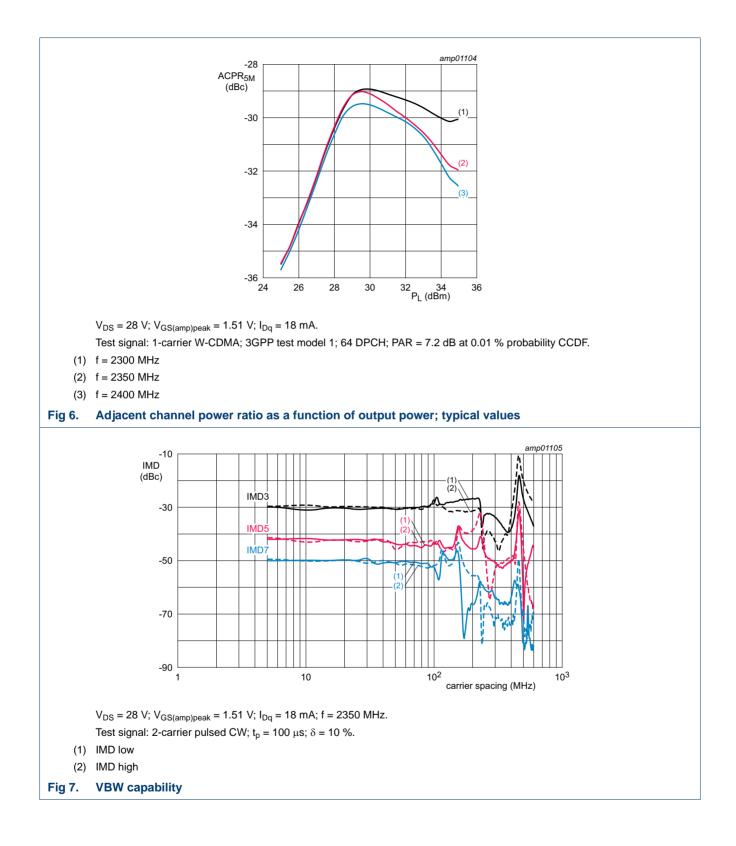


8.2 Graphs

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9. Package outline

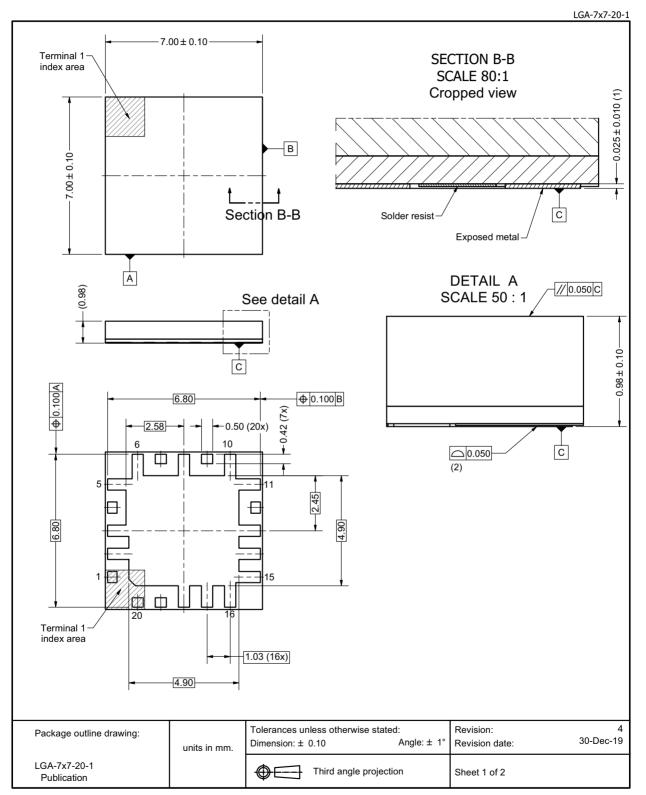


Fig 8. Package outline LGA-7x7-20-1 (sheet 1 of 2)

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LGA-7x7-20-1

			awing Notes		
	Iter	n	Description		
	1	M	etal thickness of solder pads.		
	2	Flathe	ss with respect to exposed me		
Deekeen outling deeving	1	Tolerances ur	less otherwise stated:	Revision:	4
Package outline drawing:	units in mm.	Dimension: ±			30-Dec-19
LGA-7x7-20-1			Third angle projection	Sheet 2 of 2	
		+			

Fig 9. Package outline LGA-7x7-20-1 (sheet 2 of 2)

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10. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 10.ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C2A [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	1C [2]

[1] CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V.

[2] HBM classification 1C is granted to any part that passes after exposure to an ESD pulse of 1000 V.

11. Abbreviations

Table 11. Abbreviations			
Acronym	Description		
3GPP	3rd Generation Partnership Project		
CCDF	Complementary Cumulative Distribution Function		
CW	Continuous Wave		
DPCH	Dedicated Physical CHannel		
ESD	ElectroStatic Discharge		
GEN9	Ninth Generation		
GSM	Global System for Mobile Communications		
LDMOS	Laterally Diffused Metal Oxide Semiconductor		
LTE	Long Term Evolution		
MMIC	Monolithic Microwave Integrated Circuit		
MTF	Median Time to Failure		
NR	New Radio		
PAR	Peak-to-Average Ratio		
RoHS	Restriction of Hazardous Substances		
VBW	Video BandWidth		
VSWR	Voltage Standing Wave Ratio		
W-CDMA	Wideband Code Division Multiple Access		

12. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLM9D2324-08AM v.1	20201013	Product data sheet	-	-

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13. Legal information

13.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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